L Number	Hits	Search Text	DB	Time stamp
-	1	(integrated and circuit and chip and test and adapter).ti.	USPAT	2003/04/16 14:46
-	3	(chip and test and adapter).ti.	USPAT	2003/04/17 14:02
-	1		USPAT	2003/04/16 14:47
-	1		USPAT	2003/04/16 14:47
-	1		USPAT	2003/04/16 14:47
-	1		USPAT	2003/04/16 14:47
-	28	(integrated and circuit and adapter).ti.	USPAT	2003/04/16 14:47
-	1		USPAT	2003/04/16 14:48
-	1		USPAT	2003/04/16 14:48
-	1		USPAT	2003/04/16 14:48
-	3	(chip and test and adapter).ti.	USPAT	2003/04/17 14:02
-	17	(chip and adapter).ti.	USPAT	2003/04/17 14:02
-	98	(chip and adapter).ab.	USPAT	2003/04/17 14:02
-	4	((chip and adapter).ab.) and adhesive near layer	USPAT	2003/04/17 14:03
-	78555	(((chip and adapter).ab.) and adhesive near layer) amd polyamide	USPAT	2003/04/17 14:03
-	1	(((chip and adapter).ab.) and adhesive near layer) and polyamide	USPAT	2003/04/17 14:03
-	0	(((chip and adapter).ab.) and adhesive near layer) and acrylic	USPAT	2003/04/17 14:03
-	152695	3and acrylic	USPAT	2003/04/17 14:03
-	3	((chip and adapter).ab.) and acrylic	USPAT	2003/04/17 14:03
-	0	(((chip and adapter).ab.) and acrylic) and polyamide	USPAT	2003/04/17 14:04
-	1	((((chip and adapter).ab.) and adhesive near layer) and polyamide) and polyamide	USPAT	2003/04/17 14:06
-	18839	polyamide and acrylic and layer$1	USPAT	2003/04/17 14:06
-	18	(polyamide and acrylic) near layer$1	USPAT	2003/04/17 14:07